## CLAIMS: I claim:

## 1. -8. (CANCELED)

- 9. (NEW) A prepared chips for promoting the growth of seed comprising an organic sheeting support 20 mixed with a variety of seed 22, and bonded together at least partially by an organic adhesive 24 whereby said chips are made in the forms of flakes 30, strips 32, straws 34, and grains 36.
  - 10. (NEW) The chips according to claim 9 wherein said organic sheeting support 20 is selected from the group of: organic materials, cellulosic material, paper, tissue paper, recycled paper, coir, fine-grained straws, fine-grained grass leaves, bagasse, wood chips, bark chips, leaves chips, peat moss, biodegradable fibers, clean biodegradable recycled fibers, new biodegradable synthetic fibers, and combinations thereof.
  - 11. (NEW) The chips according to claim 9 wherein said organic adhesive 24 is selected from the group of: organic materials, natural glue, corn syrup, rice syrup, latex, and combinations thereof.
  - 12. (NEW) The chips according to claim 9 wherein said exterior surfaces of the chips 40 are painted and printed with drawings and logotypes.
- 13. (NEW) A prepared chips for promoting the growth of seed comprising a variety of seed 22 enclosed between two layers of organic sheeting support 20 and bonded together at least partially by an organic adhesive 24 whereby said chips are made in the forms of flakes 30, strips 32, straws 34, and grains 36.

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- 14. (NEW) The chips according to claim 13 wherein said organic sheeting support 20 is selected from the group of: organic materials, cellulosic material, paper, soft paper, tissue paper, recycled paper, coir, fine-grained straws, fine-grained grass leaves, bagasse, wood chips, bark chips, leaves chips, peat moss, biodegradable fibers, clean biodegradable recycled fibers, new biodegradable synthetic fibers, and combinations thereof.
- 15. (NEW) The chips according to claim 13 wherein said organic adhesive 24 is selected from the group of: organic materials, natural glue, corn syrup, rice syrup, latex, and combinations thereof.
- 16. (NEW) The chips according to claim 13 wherein said exterior surfaces of the chips 40 are painted and printed with drawings, logotypes, and emblems.
- 17. (NEW) A prepared chips for promoting the growth of seed comprising an organic sheeting support 20 mixed with a variety of seed 22 and bonded together at least partially by an organic adhesive 24 whereby the exterior form of the chips 42 is made resembling forms of advertising designs.
- 18. (NEW) A prepared chips for promoting the growth of seed comprising a variety of seed 22 enclosed between two layers of organic sheeting support 20 and bonded together at least partially by an organic adhesive 24, whereby the exterior form of the chips 42 is made resembling forms of advertising designs.

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- 19. (NEW) A method of manufacturing chips for promoting the growth of seed comprising the steps of:
  - a. providing a first sheeting support on conveyor,
  - b. applying seed on top of said first sheeting support,
  - applying a second organic sheeting support covering said seed and said first organic sheeting support,
  - d. spraying on said second organic sheeting support an organic adhesive mixed with nutrients.
  - e. applying soft roller on top compressing gently said chips dispersing said organic adhesive throughout said seed and first organic sheeting support,
  - f. drying said chips,
  - g. painting and printing said chips as necessarily,
  - h. shaping and cutting chips as necessarily.
  - i. packing chips in convenient containers.
- 20. (NEW) A method of establishing a vegetative layer on grounds, and synthetic surfaces, the method comprising the steps of:
  - a. providing prepared chips for promoting the growth of seed,
  - b. applying the chips on the surface following predetermined patterns and watering chips as installation advance,
  - c. watering chips at least once a day,
  - d. waiting for seedling germination,
  - e. waiting for plants establishment,
  - f. providing 1 inch of water per week after said plants establishment occur,
  - g. pruning, mowing, and nurturing said plants establishment as necessarily.